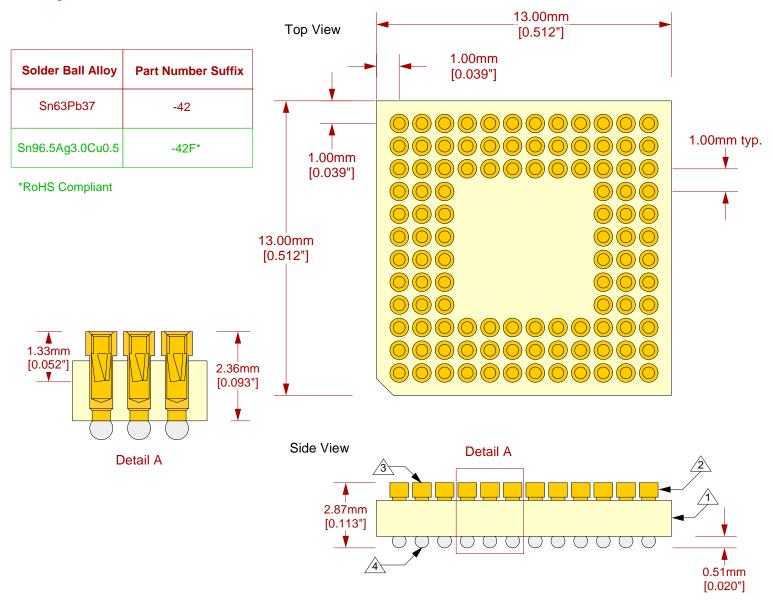
## Patent Pending

## Ordering Information:



## **CONTACT DATA**

Accepts 0.20mm - 0.33mm Diameter pins 3-finger

37/25 gram, Initial insertion force (with 0.254mm/0.203mm dia. pin) 30/22 gram, normal force (with 0.254mm/0.203mm dia. pin)

20/17 gram, extraction force (with 0.254mm0.203mm dia. pin)

Substrate: 1.59mm ±0.18mm [0.0625" ±0.007"] FR4/G10 or equivalent high temp material. (RoHS)



Pins: material- Brass Alloy 360 1/2 hard; finish-0.25μm [10μ"] Au over 1.27μm [50μ"] Ni (min.).



Contacts: Beryllium Copper Alloy172, HT; Finish-0.25μm [10μ"] Au over 1.27μm [50μ"] Ni (min.).



Solder Balls (See table above)

## Description: Giga-snaP BGA SMT Foot

108 position (1.0mm pitch) gold plated female receptacle pins to SMT solder balls (BGA type). Pin asignment 1:1.

Tolerances: diameters ±0.03mm [±0.001"], PCB perimeters ±0.18mm [±0.007"], PCB thicknesses ±0.18mm [±0.007"], pitches (from true position) ±0.08mm [±0.003"], all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

SF-BGA108B-B-42(F) Drawing	Status: Released	Scale: 6:1		Rev: C
© 2004 IRONWOOD ELECTRONICS, INC. PO BOX 21151 ST. PAUL, MN 55121 Tele: (651) 452-8100 www.ironwoodelectronics.com	Drawing: B Fedde		Date: 8/23/04	
	File: SF-BGA108B-B-42 Dwg		Modified: 1/5/06	